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U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office

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Attorney Docket No. 389.45815X00

To the Honorable Commissioner of Patents and Trademarks: Pi		
1. Name of conveying party(ies): Eiji KAMIYAMA Seiichi NAKAMURA Tetsuya NAKAI MAR 2 4 2006 W	2. Name and address of receiving party(ies) Name: Sumco Corporation Street Address: 2-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8634 Japan	
Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No	Tokyo 103-8034 Japan	
3. Nature of conveyance/ Execution Date: 2/10/06; 2/10/06; 2/10/06.		
	Additional name(s) & address(es) attached? ☐ Yes ⊠ No	
	This document is being filed together with a new application.	
A. Patent Application No.(s) 11/331,216	B. Patent Registration No.(s)	
Additional number(s) att. 5. Name and address of party to whom correspondence	<i>p</i> -1	
concerning document should be mailed: Name: ANTONELLI, TERRY, STOUT & KRAUS, LLP Internal Address: 1300 NORTH 17 TH STREET – SUITE 1800	6. Total number of applications and patents involved 1 7. Total fee (37 CFR 3.41)	
City: ARLINGTON State: VA Zip 22209 Phone Number: (703) 312-6600 Facsimile Number: (703) 312-6666 Email Address: email@antonelli.com	8. Payment Information: a. Credit Card Last 4 numbers: 1073 Expiration date: 06/06 b. Deposit account number: 01-2135	
	Authorized User Name: William I. Solomon	
9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.		
Alan E. Schiavelli, Reg#32,087	03/24/06	
Name of Person Signing Signatu	re Date	
Total number of pages including cover sheet, attachments, and document: 2		
Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to: Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450		

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PATENT REEL: 017720 FRAME: 0181

ASSIGNMENT

(譲渡証)

IN CONSIDERATION of the sum of One Dollar (\$1 .00) or the equivalent
thereof, and other good and valuable consideration paid to Eiji KAMIYAMA,
Seiichi NAKAMURA , and <u>Tetsuya NAKAI</u> ,
citizens of Japan by SUMCO CORPORATION , a corporation organized under
the laws of Japan, located at 2-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8634
Japan , respectively, receipt of which is hereby acknowledged, we, the said Eiji
KAMIYAMA, Seiichi NAKAMURA, and Tetsuya NAKAI, do hereby sell and
assign to saidSUMCO CORPORATION _, their successors and assigns, all our
right, title and interest, in and for the United States of America, in and to

SOI SUBSTRATE, SILICON SUBSTRATE THEREFOR AND ITS MANUFACTURING METHOD

invented by us and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said SUMCO CORPORATION, their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made;

And we hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And we do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said <u>SUMCO CORPORATION</u>

Signed on the date(s) indicated aside signatures:

RECORDED: 03/24/2006

	INVENTOR(S) (発明者フルネームサイン)	Date signed (署 名 日)
1) .	Eiji Kamiyama Eiji KAMIYAMA	February 10, 2006
2) _	Seuchi Nalcamura Seiichi NAKAMURA	February 10, 2006
3) _	Jackey a Nakal	February 10, 2006

PATENT REEL: 017720 FRAME: 0182